



The 22nd International Conference on Metal
Organic Vapor Phase Epitaxy

ICMOVPE XXII

July **12** (Sun.) – **17** (Fri.), 2026

ICC JEJU, Jeju Island, Korea

Sponsorship Prospectus

Organized by

KOES 한국광전자공학회
Korea Optoelectronics Society



Welcome Message

The 22nd International Conference on Metal Organic Vapor Phase Epitaxy (ICMOVPE XXII) will be held July 12–17, 2026, at the International Convention Center Jeju (ICC JEJU), Jeju Island, Korea.

Since its first conference in 1981, ICMOVPE has become a leading international forum for sharing research and innovative ideas in both fundamental and applied aspects of MOVPE. ICMOVPE XXII will feature plenary and invited talks, oral and poster sessions, rump sessions, and industrial exhibitions, with a touch of Korean culture in the social events.

We warmly welcome you to Jeju and hope this conference provides valuable opportunities for scientific exchange, collaboration, and memorable experiences.

Sincerely,
Yong-Hoon Cho
Conference Chair of ICMOVPE XXII

Conference Information

Conference Title

The 22nd International Conference on Metal Organic Vapor Phase Epitaxy

Date

July 12 (Sun.) – 17 (Fri.), 2026

Location

ICC JEJU, Jeju Island, Korea

Expected Number of Attendees

400 Attendees

Organized by

Korea Optoelectronics Society (KOES)

Website

<https://icmovpe2026.org>



Committees

Organizing Committee

Conference Chair	Yong-Hoon Cho (KAIST, Korea)
International Program Committee Chair	Jong Kyu Kim (POSTECH, Korea)
Publication Committee Chair	Sang Wan Ryu (Chonnam Nat'l Univ., Korea)
Finance Committee Chair	Jun-Seok Ha (Chonnam Nat'l Univ., Korea)
Exhibition Committee Chair	Si-Young Bae (Pukyong Nat'l Univ., Korea)
Local Arrangement Committee Chair	Yong-Ho Ra (Jeonbuk Nat'l Univ., Korea)
General Secretary	Young Joon Hong (Sungkyunkwan Univ., Korea)

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Andre Strittmatter (Otto-von-Guericke Universität Magdeburg, Germany)	Katsuhiko Tomioka (Hokkaido University, Japan)
Xiangang Xu (Shandong University China, China)	Hui Yang (Suzhou Institute of Nano-Tech and Nano-Bionics, China)
Euijoon Yoon (Seoul National University, Korea, Korea)	



Committees

Program Committee

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Kerstin Volz (Philipps-University Marburg, Germany)	Christine Wang (MIT Lincoln Lab, USA)
Simon Watkins (Simon Fraser University, Canada)	Markus Weyers (Ferdinand-Braun-Institute, Germany)
Xiangang Xu (Shandong University, China)	C.C. Yang (National Taiwan University, Taiwan)

Important Dates

Abstract Submission Deadline	February 27, 2026
Acceptance Notification	April 24, 2026
Late News Paper Submission Deadline	May 22, 2026
Advance Registration Deadline	June 12, 2026



Sponsorship

We have a range of sponsorship packages designed to suit all your needs.

Your sponsorship in this exciting event will provide excellent opportunities for your company to expose high quality products and services to the experts from all parts of the world.

※ All sponsorship categories are filled **on a first-come, first-served basis**.

Application Procedure

- Please download the Sponsorship Application form, fill out and fax or e-mail it to the ICMOVPE XXII Secretariat (icmovpe2026@icmovpe2026.org)
- The payment must be made within a month from the issue date of your invoice.
- Please send the receipt to the secretariat for confirmation of full payment.
- All of the amount must be transferred to the bank account.

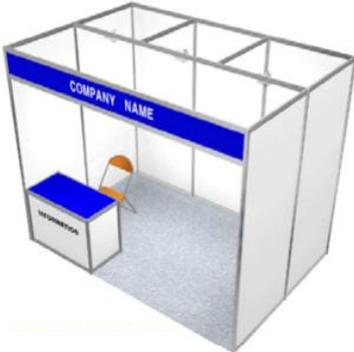
Sponsorship Levels & Benefits

Packages & Benefits	Platinum (1 available)		Diamond (2 available)	Gold (5 available)	Silver	Bronze
	USD 16,000		USD 8,000	USD 4,000	USD 2,400	USD 1,600
	KRW 20,000,000 or more		KRW 10,000,000	KRW 5,000,000	KRW 3,000,000	KRW 2,000,000
Advertisement in program book (Back matter)	Full Color, One-page Ads		Full Color, One-page Ads	Full Color, One-page Ads	Full Color, Half-page Ads	Full Color, Half-page Ads
Logo and link on e-newsletter & website	○		○	○	○	○
Listed on the conference banners	○		○	○	○	-
Logo display on screen at oral session room	○		○	○	○	-
Exhibition booth -Prefabricated Booth 3m(W)*2m(L)*2.5m(H)	Option 1 Independent Booth (Space Only)	Option 2 Prefabricated Booths	Prefabricated Booths	Prefabricated Booth	Prefabricated Booth	Prefabricated Booth
	6m*4m	3	2	1	1	-
Complimentary registration	5 persons		3 persons	2 persons	1 person	1 person



Exhibition

Exhibition Opportunity

Type	Component
<p>Independent Booth (6m*4m)</p>	<ul style="list-style-type: none"> • Only Provide exhibition space (6m*4m) • Please select the company's contractor to install your own independent booth. We only provide space and electricity.
<p>Prefabricated Booth (3,000,000 KRW (1EA))</p>	<div style="display: flex; align-items: center;">  <div style="margin-left: 20px;"> <p>※ Per one Booth</p> <ul style="list-style-type: none"> • Size : 3m(W)*2m(L)*2.5m(H) • 1 information desk / 2 chairs • Lighting and 1KW of power for 1 Booth </div> </div>
<p>Benefits</p>	<p>※ Benefits for Exhibitors (Per One Booth)</p> <ul style="list-style-type: none"> • 1 Free Registration (included lunch ticket and Conference Kit) • Logo and Web link on the Website • Logo on the Program Book



Sponsorship & Exhibition Application Form

Please fill out the below application form, and send it back to the secretariat (icmovpe2026@icmovpe2026.org)

ICMOVPE XXII Secretariat

E-mail: icmovpe2026@icmovpe2026.org / Tel: +82-42-472-7460 / Fax: +82-42-472-7459

| Company Information

Company Name			
President / CEO			
Website			
Address			
City / Country		Postal Code	
Telephone		Mobile	
E-mail		Fax	
Contact Person Name			
Job Title		Department	

| Sponsorship Application

Level	KRW	Apply (Check "✓")	
Platinum	KRW 20,000,000	Option 1 <input type="checkbox"/>	Option 2 <input type="checkbox"/>
Diamond	KRW 10,000,000		
Gold	KRW 5,000,000		
Silver	KRW 3,000,000		
Bronze	KRW 1,000,000		

| Exhibition Booth (Only for Platinum ~ Silver levels)

Exhibition Booth Application for the Diamond ~ Silver levels is optional without additional charge on **first-come, first-served basis**. If you plan for an exhibition booth at ICMOVPE XXII, please check the box below.

Exhibition Booth Application	
<input type="checkbox"/> YES	<input type="checkbox"/> NO

| Account Information

Account Holder	사단법인 한국광전자공학회 조용훈
Account Number	100-035-605475
Bank Name	Shinhan Bank
SWIFT BIC	SHBKKRSE
Bank Address	Shinhan Bank Donam-dong Branch, 89 Dongsomun-ro, Seongbuk-gu, Seoul, Republic of Korea

Name of Applicant: _____ Date: _____

Signature: _____